



**IN THE SPECIFICATION:**

Please amend the specification as follows:

The paragraph beginning on page 11, at line 15, has been amended as follows:

Referring to Figs. 2A to 2D, in a preferred embodiment, the bowl 12A, 12B, 12C, 12D of the cathode leg support 11 is designed with ~~multiple concentric recesses~~ at least one concentric recess 17. This helps in alignment of the chip. Also, a proper amount of adhesive can be added according to the size of the chip to enhance the adhesion. There is one or more ~~stage steps~~ of recessed faces. For example, Fig. 2A shows a ~~one-stage one-step~~ bowl 12A, Fig. 2B shows a ~~two-stage two-step~~ bowl 12B, Fig. 2C shows a ~~three-stage three-step~~ bowl 12C and Fig. 2D shows a ~~multistage (four-stage)~~ multi-step (four-step) bowl 12D. Accordingly, the bowl structure ~~provides~~ can provide multiple focusing and multiple refracting effects. In addition, the area of the light beam is doubled and the projecting length of the light beam is doubled. By means of the ~~two-stage, three-stage and multistage~~ two-step, three-step, and multi-step bowl designs, high efficiency optical physical effect can be achieved to enhance the illumination.

The paragraph beginning on page 12, at line 3, has been amended as follows:

Referring to the respective figures, the bracket of the present invention can have two heat-radiating wings 13 ~~and or~~ four heat-radiating wings 13 according to different requirements. More than two fixing posts 16 can be disposed under the bottom of the bracket for insertion in a PC board. In the case that the cathode leg support 11 is free from any column hole 14, the bracket is a solid ~~one~~ bracket. The bottom face of ~~such~~ each solid bracket is fully attached to and contacts with the conductive metal film on the PC board to achieve better heat-radiating effect. Another type of cathode leg support 11 is formed with several column through holes 14 and has hollow structure 18 and is called a hollow bracket. Each hollow. ~~Such bracket is hollow one. Such bracket is connected with the conductive metal film of the PC board by various measures. Some of them are partially have less surface area attached to the PC board ( as shown in Figs. 1B and 4F-1I).~~ Some of them ~~are~~

~~partially~~ have a first bottom surface attached to the PC board and ~~partially~~ a second bottom surface suspended above the circuit board ( as shown in Figs. 1C ~~to 1E~~ and ~~1G 1J to 1L~~). Some of them ~~are~~ partially have a first bottom surface attached to the PC board and ~~partially~~ a second bottom surface suspended above the circuit board and ~~partially~~ passed a column 141 passing through the PC board ~~along the column 141~~ ( as shown in Figs. ~~1D and 1H~~ 1F, 1G, 1M, and 1N). The hollow bracket can achieve best heat-radiating effect.